

MOSFET

OptiMOS[™]5 Power-MOSFET, 30 V

Features

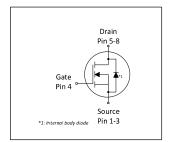
- Optimized for high performance buck converters (Server,VGA)
 Very low FOMQ_{OSS} and FOMQ_g for high frequency SMPS
 Very low on-resistance R_{DS(on)} @ V_{GS}=4.5 V
 100% avalance tested

- Superior thermal resistance
- N-channel
- Qualified according to JEDEC¹⁾ for target applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Table 1 **Key Performance Parameters**

| Parameter | Value | Unit |
|-------------------------|-------|------|
| $V_{	t DS}$ | 30 | V |
| R _{DS(on),max} | 4.4 | mΩ |
| I _D | 61 | Α |
| Qoss | 7.2 | nC |
| Q _G (0V4.5V) | 5.2 | nC |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|----------------|---------|---------------|
| BSZ0506NS | PG-TSDSON-8 FL | 0506NS | - |

OptiMOS[™]5 Power-MOSFET, 30 V BSZ0506NS



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OptiMOS[™]5 Power-MOSFET, 30 V **BSZ0506NS**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

| Davamatav | 0 | Values | | | | |
|--|----------------------|--------|------------------|----------------------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | I _D | - | - - - - | 61 39 56 35 15 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W ²⁾ |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 244 | Α | <i>T</i> _C =25 °C |
| Avalanche current, single pulse ⁴⁾ | I _{AS} | - | - | 20 | Α | T _C =25 °C |
| Avalanche energy, single pulse | E _{AS} | - | - | 20 | mJ | $I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω |
| Gate source voltage | V_{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | 27 2.1 | - | W | T _C =25 °C T _A =25 °C, R _{thJA} =60 K/W |
| Operating and storage temperature $T_{\rm j}, T_{\rm stg}$ | | -55 | - | 150 | °C | IEC climatic category; DIN IEC 68-1: 55/150/56 |

2 Thermal characteristics

Table 3 **Thermal characteristics**

| Baramatar | Symbol | Values | | | linit | Note / Test Condition |
|--|-------------------|--------|------|------|-------|-----------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case | R _{thJC} | - | - | 4.6 | K/W | - |
| Device on PCB, 6 cm ² cooling area ⁴⁾ | R_{thJA} | _ | _ | 60 | K/W | - |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See figure 3 for more detailed information

4) See figure 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

| _ | 0 | | Value | s | 1114 | N 4 7 4 0 100 | |
|----------------------------------|----------------------|------|------------|------------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Drain-source breakdown voltage | V _{(BR)DSS} | 30 | - | - | V | V _{GS} =0 V, I _D =1 mA | |
| Gate threshold voltage | $V_{\rm GS(th)}$ | 1.2 | 1.6 | 2 | V | $V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=250\ \mu{\rm A}$ | |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μA | V _{DS} =24 V, V _{GS} =0 V, T _i =25 °C V _{DS} =24 V, V _{GS} =0 V, T _i =125 °C | |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V | |
| Drain-source on-state resistance | R _{DS(on)} | - | 4.4 3.5 | 5.3 4.4 | mΩ | V _{GS} =4.5 V, I _D =20 A V _{GS} =10 V, I _D =20 A | |
| Gate resistance | R _G | - | 1 | 1.7 | Ω | - | |
| Transconductance | g_{fs} | 49 | 98 | - | S | $ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 30 \text{ A}$ | |

 Table 5
 Dynamic characteristics

| Parameter | Cumb al | Values | | 11:4 | Note / Test Condition | |
|----------------------------------|------------------|----------------|------|-----------------------|-----------------------|--|
| | Symbol | Min. Typ. Max. | Unit | Note / Test Condition | | |
| Input capacitance ¹⁾ | C _{iss} | - | 700 | 950 | pF | V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz |
| Output capacitance ¹⁾ | Coss | - | 220 | 300 | pF | V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz |
| Reverse transfer capacitance | C _{rss} | - | 16 | - | pF | V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 2.3 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Rise time | t _r | - | 2.4 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 13 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Fall time | t _f | - | 2.0 | - | ns | $V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |

Gate charge characteristics²⁾ Table 6

| Parameter | Cymph al | Values | | | I I m i 4 | Note / Took Condition |
|------------------------------|-----------------------------|--------|------|------|-----------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 1.9 | - | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge at threshold | Q _{g(th)} | - | 1.1 | - | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate to drain charge | Q_{gd} | - | 1.4 | - | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Switching charge | Q _{sw} | - | 2.2 | - | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge total | Q_g | - | 5.2 | 7.2 | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate plateau voltage | V _{plateau} | - | 2.7 | - | V | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge total | Qg | - | 11 | 15 | nC | V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 10 V |
| Gate charge total, sync. FET | Q _{g(sync)} | - | 4.8 | _ | nC | V _{DS} =0.1 V, V _{GS} =0 to 4.5 V |
| Output charge | Qoss | - | 7.2 | - | nC | V _{DD} =15 V, V _{GS} =0 V |

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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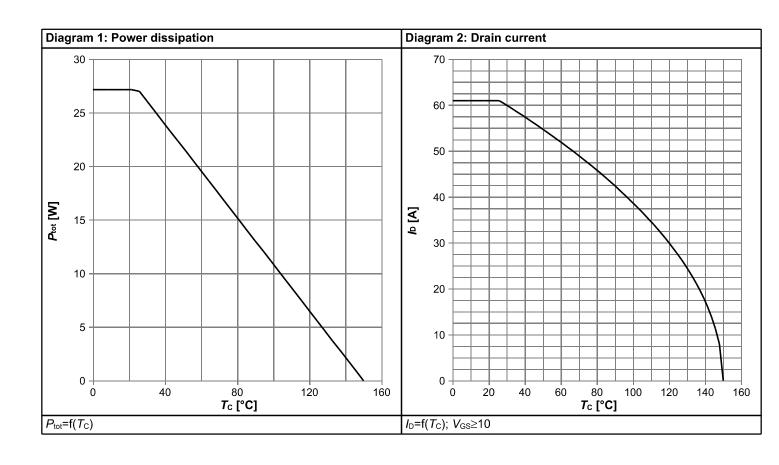


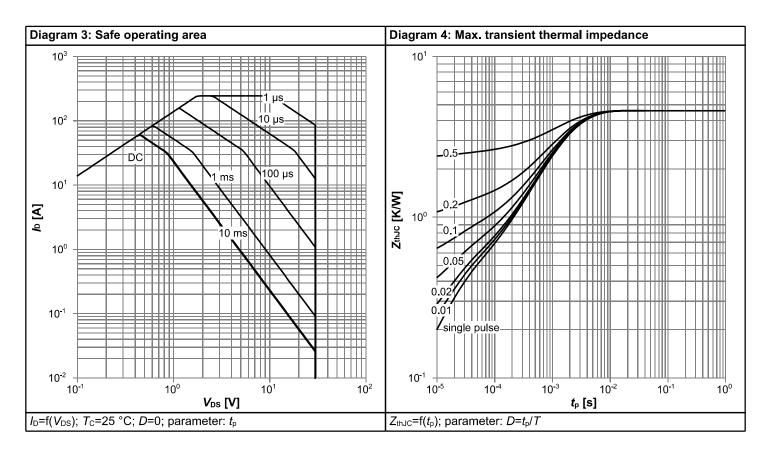
Table 7 Reverse diode

| Dougnoston. | Current ed | | Values | | | Nata / Tant Canadition | |
|----------------------------------|----------------------|------|--------|------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Diode continuous forward current | I _S | - | - | 24 | Α | T _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 244 | Α | T _C =25 °C | |
| Diode forward voltage | V _{SD} | - | 0.81 | 1.1 | V | V _{GS} =0 V, I _F =20 A, T _j =25 °C | |
| Reverse recovery charge | Qrr | - | 10 | - | nC | V _R =15 V, I _F =30A, di _F /dt=400 A/μs | |

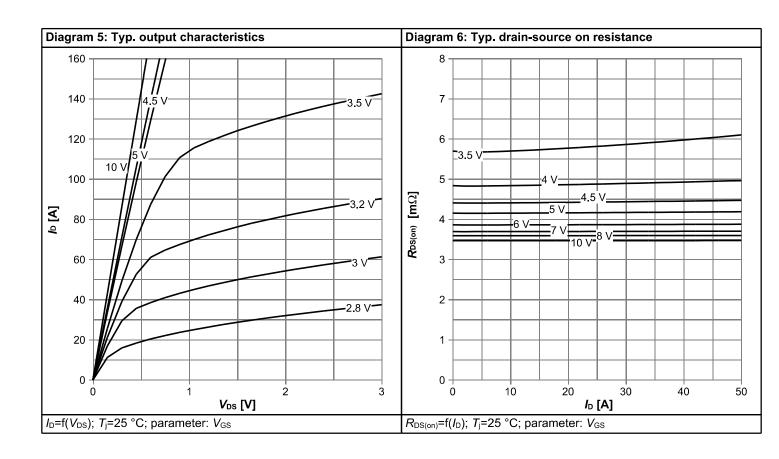


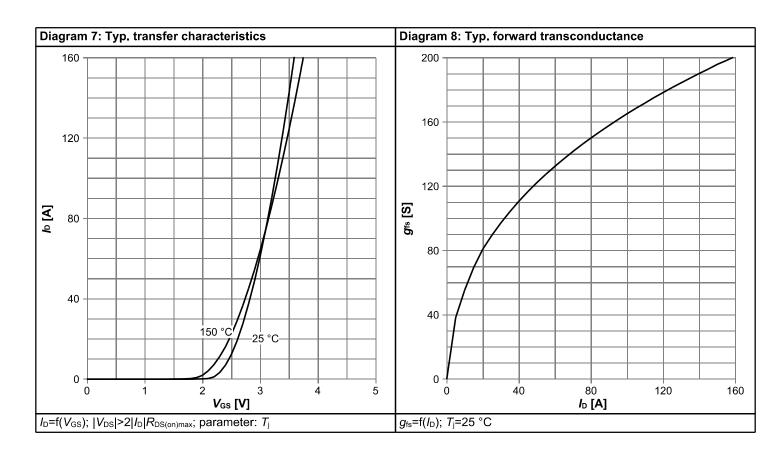
4 Electrical characteristics diagrams



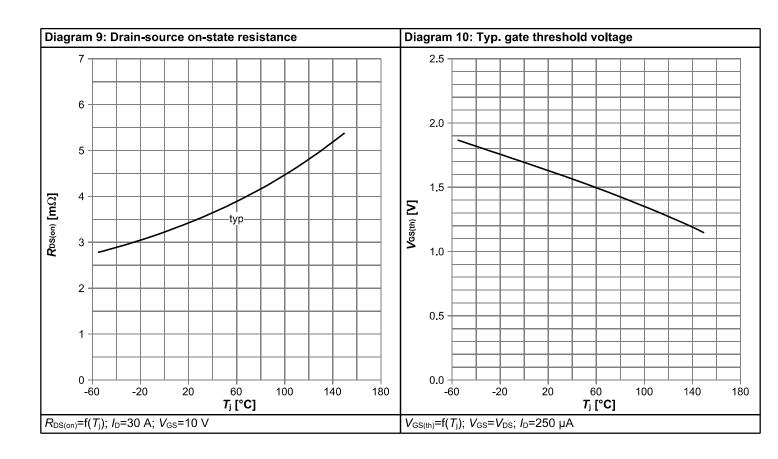


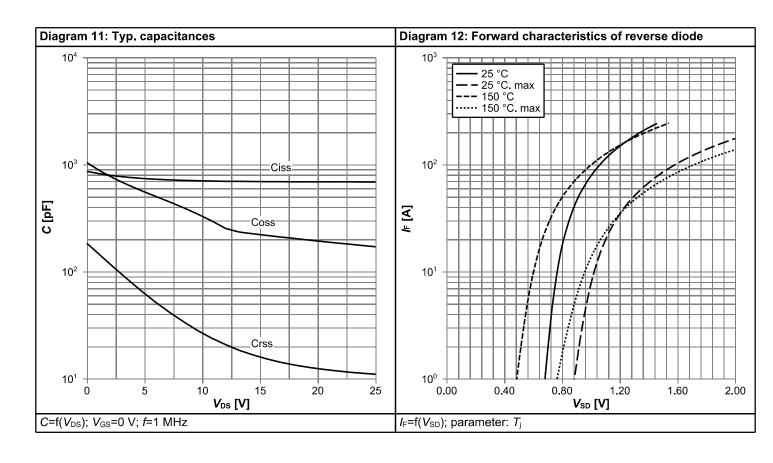




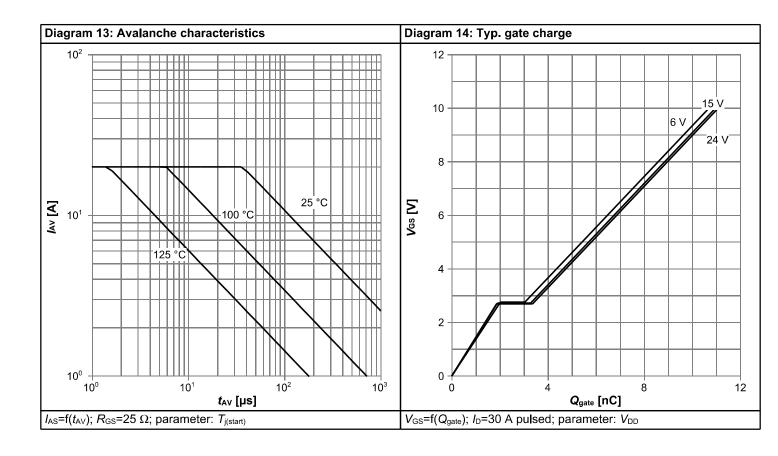


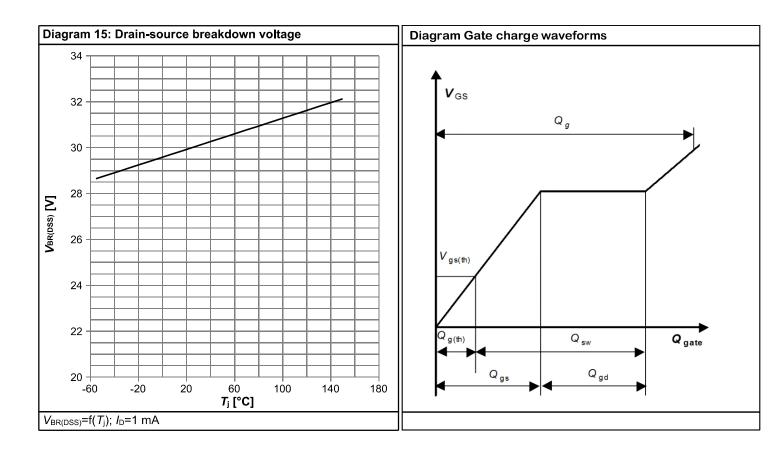






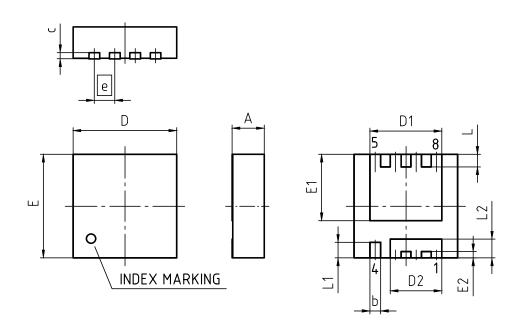








5 Package Outlines



| PACKAGE - GROUP NUMBER: | PG- | TSDS | ON-8-U03 | |
|----------------------------|------|--------|------------|--|
| REVISION: 03 | | DATE: | 20.10.2020 | |
| DIMENSIONS | N | MILLIM | ETERS | |
| DIMENSIONS | MIN | ٧. | MAX. | |
| Α | 0.9 | 0 | 1.10 | |
| b | 0.2 | 4 | 0.44 | |
| С | | (0. | 20) | |
| D | 3.2 | 0 | 3.40 | |
| D1 | 2.1 | 9 | 2.39 | |
| D2 | 1.5 | 4 | 1.74 | |
| E | 3.2 | 0 | 3.40 | |
| E1 | 2.0 | 1 | 2.21 | |
| E2 | 0.1 | 0 | 0.30 | |
| е | 0.65 | | | |
| L | 0.30 | | 0.50 | |
| L1 | 0.4 | 0 | 0.60 | |
| L2 | 0.5 | 0 | 0.70 | |
| aaa | · | 0.0 | 06 | |

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

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Revision History

BSZ0506NS

Revision: 2021-02-16, Rev. 2.2

Previous Revision

| Trevious Nevicion | | | | | |
|-------------------|------------|---|--|--|--|
| Revision | Date | Date Subjects (major changes since last revision) | | | |
| 2.0 | 2015-04-27 | Release of final version | | | |
| 2.1 | 2020-11-20 | Update package drawing | | | |
| 2.2 | 2021-02-16 | Update Max Id current rating | | | |

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